conductive material [is a non-conductive particulate material] comprises alumina or boron nitride or both.

3. (Amended) The electrically resistive composite material of claim [2 wherein the particulate material is selected from metal oxides, metal nitrides, ceramics, and mixtures thereof] I wherein the conductive material comprises copper.

conid

- 4. (Amended) The electrically resistive composite material of claim [3 wherein the non-conductive particulate materials is selected from the group consisting of boron nitride, silicon carbide, alumina, silica, platinum oxide, tantalum nitride, talc, polyethylene tetra-fluoroethylene (PTFE), epoxy powders, and mixtures thereof] 1 wherein the conductive material comprises is not copper.
- 5. (Amended) The electrically resistive composite material of claim 1 [wherein the conductive material is a metal, metalloid, alloy, or combination thereof] which has a resistivity of from about 1 to about 10,000 ohms/square.
- 8. (Amended) The multi-layer foil of claim 6 [wherein the electrically resistive composite material layer non-conductive material is a non-conductive particulate material selected from metal oxides, metal nitrides, ceramics, and mixtures thereof] wherein the conductive material comprises copper.

- 9. (Amended) The multi-layer foil of claim [8 wherein the non-conductive particulate materials is selected from the group consisting of boron nitride, silicon carbide, alumina, silica, platinum oxide, tantalum nitride, talc, polyethylene tetra-fluoroethylene (PTFE), epoxy powders, and mixtures thereof 6 wherein the conductive material comprises is not copper.
- 10. (Amended) The multi-layer foil of claim 6 wherein the conductive material [is a metal, metalloid, alloy, or combination thereof] <u>comprises nickel</u>.

Add.

11. (Amended) A multi-layer foil comprising a copper metal layer <u>having a shiny surface</u>, and an electrically resistive composite material layer associated with the copper metal layer shiny surface wherein the electrically resistive composite material layer includes from about 0.01 to about 99.9 area % of a conductive metal other than copper and from about 0.01 to about 99.9 area % of particles of a non-conductive material selected from alumina, boron nitride, and mixtures thereof.

Please add the following claims:

- 21. The electrically resistive composite material of claim 1 wherein the conductive material comprises comprises nickel.
- 22. The electrically resistive composite material of claim 1 wherein the amount of non-conductive material in the electrically resistive composite material ranges from about 0.01 to about 99.9 area %.

 $\mathcal{R}^{\mathcal{I}}$ 

- 23. The electrically resistive composite material of claim 1 wherein the amount of conductive material in the electrically resistive composite material ranges from about 0.01 to about 99.9 area %.
- 24. The multi-layer foil of claim 6 wherein the conductive metal layer comprises copper.
- 25. The multi-layer foil of claim 6 wherein the conductive metal layer comprises copper and the conductive material does not comprise copper.
- 26. The multi-layer foil of claim 6 wherein the conductive metal layer comprises copper and the conductive material comprises nickel.